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[] yes [X] no		Street Address:	416, Maetan-dong, Yeongtong- gu, Kyungki-do
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06/02/2006 HLE333 00000027 11444184 05 FC:8021

**PATENT** 

**REEL: 017948 FRAME: 0449** 

## ASSIGNMENT DOCKET NO.: 8111L-31 (SLP050217US)

AS A BELOW NAMED INVENTOR, I, and each of us, individually hereby declare that: IN CONSIDERATION of the sum of TEN (\$10.00) dollars or the equivalent thereof, and other good and valuable consideration, the receipt of which from the hereinafter named Assignee is hereby acknowledged, I do hereby sell, assign and forever grant and convey unto:

ASSIGNEE: Samsung Electronics Co., Ltd.

ADDRESS: 416, Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, KOREA

Who is my Assignee, and to the successes and assigns of my Assignee, all my right, title and interest, in and for the United States of America and all other countries, including all rights of priority, in and to the invention entitled:

TITLE: METHOD OF MANUFACTURING THIN FILM TRANSISTOR SUBSTRATE

invented by me (if only one inventor is named below) or us (if more than one inventor is named below) and described in an application for a United States patent the specification of which is either attached hereto or otherwise accompanies this Assignment or indicates an attorney docket no. 8111L-31 (SLP050217US) or is more particularly identified as:

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AND I hereby covenant and agree to sign and execute any further documents or instruments which may from time-to-time be either necessary, lawful, proper or requested by the Assignee, in the prosecution of the above-named application or in the preparation and prosecution of any certificate of correction, division, continuation, continuation-in-part, reissue, re-examination, in any amendment, extension, or interference proceeding, whether administrative or judicial, or otherwise, to secure the title hereto in said Assignee;

AND I do hereby authorize and request the Commissioner of Patents and Trademarks to issue said Patent or Patents to the Assignee, and I hereby appoint as my, or our attorney, and authorize and request Frank Chau, Reg. No. 34,136, to insert on this Assignment any further identification or to complete such identification which may be either necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

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IN WITNESS WHEREOF, I and we have set our hands and seals on the dates written beside my and our respective names:

**INVENTOR(S)** 

**Date Signed** 

Eou-sik CHO

22 May 2006

2) Lin, Tayson

22 May 2006

**RECORDED: 05/31/2006** 

PATENT REEL: 017948 FRAME: 0451